

Electronic Patent Application Fee Transmittal

Application Number:	10570663			
Filing Date:	06-Mar-2006			
Title of Invention:	METHOD FOR PRODUCING BONDED WAFER			
First Named Inventor/Applicant Name:	Akihiko Endo			
Filer:	Arnold Turk			
Attorney Docket Number:	P29122			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1440	1440
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Total in USD (\$)				1740